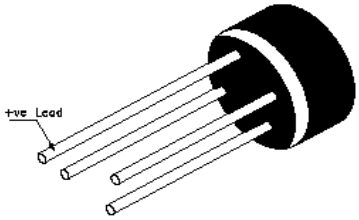
SILICON BRIDGE RECTIFIERS

W005M - W10M

WOM
PLASTIC PACKAGE



Features :

1). The Plastic Package Carries Underwriters laboratory Flammability Classification 94V-0
2). Low Reverse Leakage
3). High Forward Surge Current Capability
4). High Temperature Soldering Guaranteed :
260°C/10 seconds, 0.375"(9.5mm) Lead Length, 5lbs.(2.3Kg) tension
5). Weight : 1.2grams

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at T_a=25°C Ambient Temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%

DESCRIPTION		SYMBOL	W005M	W01M	W02M	W04M	W06M	W08M	W10M	UNIT
Maximum Repetitive Peak Reverse Voltage		V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage		V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage		V_{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Output Rectified Current at T_A=25ºC (Note 2.)		$I_{F(AV)}$	1.5							A
Peak Forward Surge Current, 8.3ms single half sine-wave superimposed on rated load (JEDEC method)		I_{FSM}	50							A
Rating for Fusing (t≤8.3ms)		I^2t	10							A^2s
Maximum Instantaneous Forward Voltage Drop Per Bridge Element at 1A		V_F	1.0							V
Maximum DC Reverse Current at Rated DC Blocking Voltage	T_A=25°C	I_R	10							µA
	T_A=100°C		1							mA
Typical Junction Capacitance (Note 1.)		C_J	15							pF
Typical Thermal Resistance		$R_{\theta JA}$	40							°C/W
Operating Junction Temperature Range		T_J	- 55 to +125							°C
Storage Temperature Range		T_{stg}	- 55 to +150							°C

Notes :

1. Measured at 1.0 MHz and applied reverse voltage of 4.0V.
2. Unit mounted on PCB with 0.22 X 0.22" (5.5 X 5.5mm) copper pads, 0.375" (9.5mm) lead length.

TYPICAL CHARACTERISTICS CURVES

FIG. 1- FORWARD CURRENT DERATING CURVE

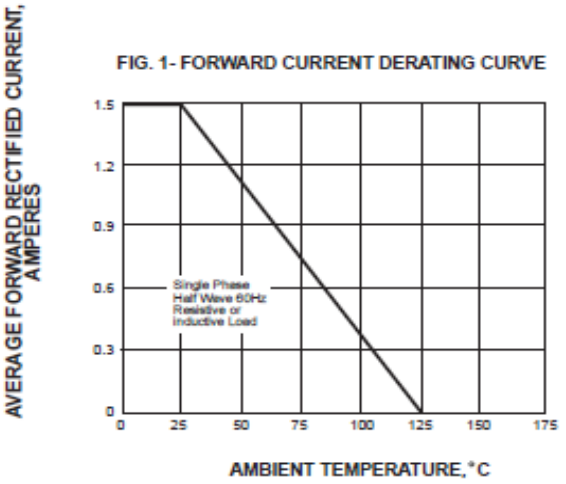


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

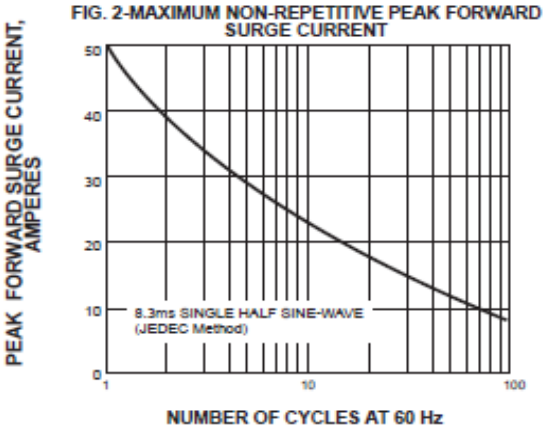


FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

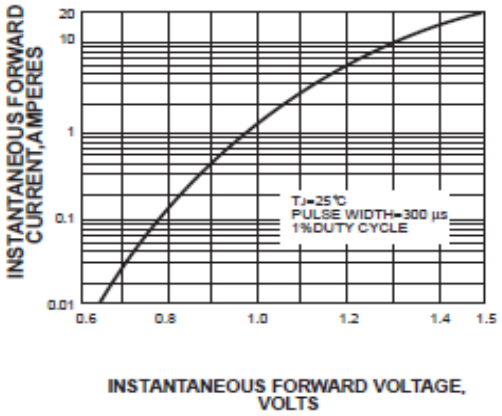


FIG. 4-TYPICAL REVERSE CHARACTERISTICS

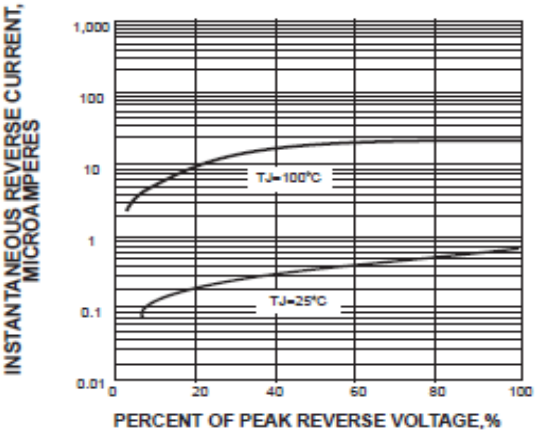


FIG. 5-TYPICAL JUNCTION CAPACITANCE

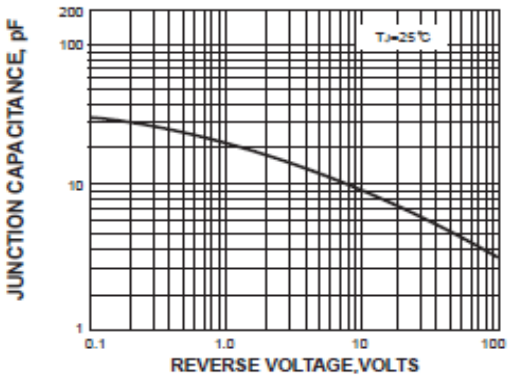
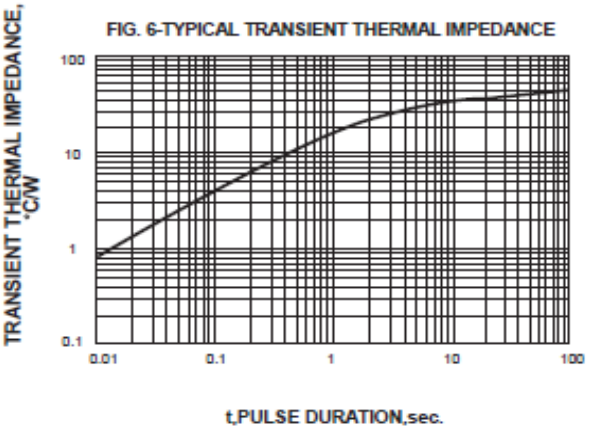
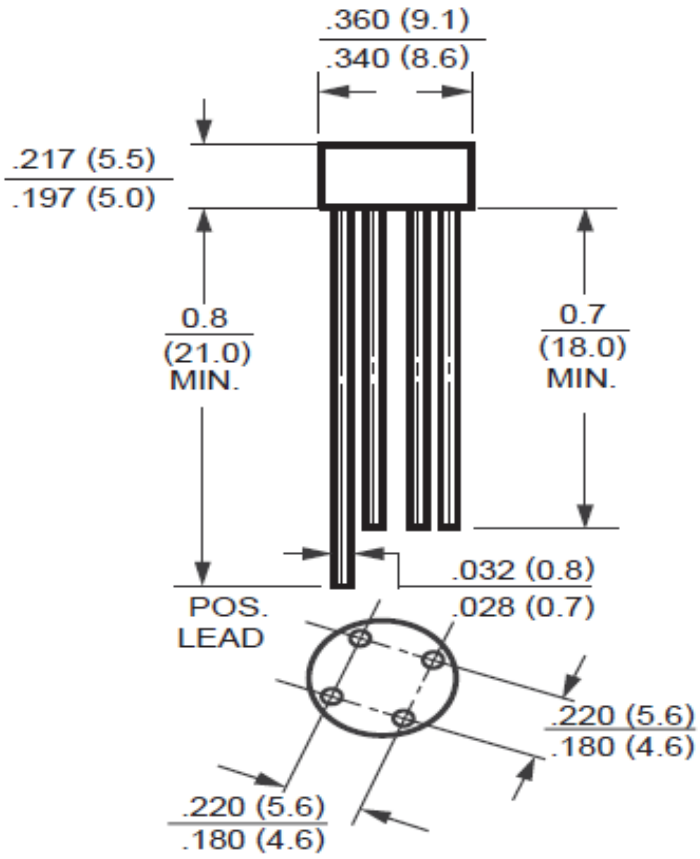


FIG. 6-TYPICAL TRANSIENT THERMAL IMPEDANCE



WOM PACKAGE OUTLINE AND DIMENSION



Dimensions in inches and (millimeters)

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